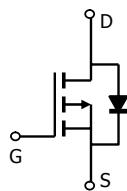
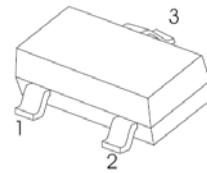


### ■ Features

- $V_{DS}$  (V) = -30V
- $I_D$  = -2.6 A ( $V_{GS}$  = -10V)
- $R_{DS(ON)} < 130\text{m}\Omega$  ( $V_{GS}$  = -10V)
- $R_{DS(ON)} < 200\text{m}\Omega$  ( $V_{GS}$  = -4.5V)
- Pb-Free Package May be Available. The G-Suffix Denotes a Pb-Free Lead Finish

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### ■ Absolute Maximum Ratings $T_a = 25^\circ\text{C}$

| Parameter                               | Symbol         | Rating     | Unit                      |
|---|----------------|------------|---------------------------|
| Drain-Source Voltage                    | $V_{DS}$       | -30        | V                         |
| Gate-Source Voltage                     | $V_{GS}$       | $\pm 20$   | V                         |
| Continuous Drain Current                | $I_D$          | -2.6       | A                         |
| $T_A = 70^\circ\text{C}$                |                | -2.2       |                           |
| Pulsed Drain Current                    | $I_{DM}$       | -20        |                           |
| Power Dissipation                       | $P_D$          | 1.4        | W                         |
| $T_A = 70^\circ\text{C}$                |                | 1          |                           |
| Thermal Resistance, Junction-to-Ambient | $R_{thJA}$     | 125        | $^\circ\text{C}/\text{W}$ |
| Thermal Resistance, Junction-to-Case    | $R_{thJC}$     | 80         | $^\circ\text{C}/\text{W}$ |
| Junction and Storage Temperature Range  | $T_J, T_{STG}$ | -55 to 150 | $^\circ\text{C}$          |

■ Electrical Characteristics  $T_a = 25^\circ\text{C}$ 

| Parameter                             | Symbol              | Testconditions   | Min | Typ   | Max       | Unit             |
|---------------------------------------|---------------------|--|-----|-------|-----------|------------------|
| Drain-Source Breakdown Voltage        | $V_{DSS}$           | $I_D=250 \mu\text{A}, V_{GS}=0\text{V}$                                  | -30 |       |           | V                |
| Zero Gate Voltage Drain Current       | $I_{DSS}$           | $V_{DS}=-24\text{V}, V_{GS}=0\text{V}$                                   |     |       | -1        | $\mu\text{A}$    |
|                                       |                     | $V_{DS}=-24\text{V}, V_{GS}=0\text{V}, TJ=55^\circ\text{C}$              |     |       | -5        |                  |
| Gate-Body leakage current             | $I_{GSS}$           | $V_{DS}=0\text{V}, V_{GS}=\pm 20\text{V}$                                |     |       | $\pm 100$ | nA               |
| Gate Threshold Voltage                | $V_{GS(\text{th})}$ | $V_{DS}=V_{GS}, I_D=-250 \mu\text{A}$                                    | -1  | -1.9  | -3        | V                |
| Static Drain-Source On-Resistance     | $r_{DS(\text{ON})}$ | $V_{GS}=-10\text{V}, I_D=-2.6\text{A}$                                   |     | 97    | 130       | $\text{m}\Omega$ |
|                                       |                     | $V_{GS}=-10\text{V}, I_D=-2.6\text{A}, TJ=125^\circ\text{C}$             |     | 135   | 150       |                  |
|                                       |                     | $V_{GS}=-4.5\text{V}, I_D=-2\text{A}$                                    |     | 166   | 200       |                  |
| On state drain current                | $I_{D(\text{ON})}$  | $V_{GS}=-4.5\text{V}, V_{DS}=-5\text{V}$                                 | -5  |       |           | A                |
| Forward Transconductance              | $g_{fs}$            | $V_{DS}=-5\text{V}, I_D=-5\text{A}$                                      | 3   | 3.8   |           | S                |
| Input Capacitance                     | $C_{iss}$           | $V_{GS}=0\text{V}, V_{DS}=-15\text{V}, f=1\text{MHz}$                    |     | 302   | 370       | pF               |
| Output Capacitance                    | $C_{oss}$           |  |     | 50.3  |           | pF               |
| Reverse Transfer Capacitance          | $C_{rss}$           |  |     | 37.8  |           | pF               |
| Gate resistance                       | $R_g$               | $V_{GS}=0\text{V}, V_{DS}=0\text{V}, f=1\text{MHz}$                      |     | 12    | 18        | $\Omega$         |
| Total Gate Charge (10V)               | $Q_g$               | $V_{GS}=-4.5\text{V}, V_{DS}=-15\text{V}, I_D=-2.6\text{A}$              |     | 6.8   | 9         | nC               |
| Total Gate Charge (4.5V)              |                     |  |     | 2.4   |           | nC               |
| Gate Source Charge                    | $Q_{gs}$            |  |     | 1.6   |           | nC               |
| Gate Drain Charge                     | $Q_{gd}$            |  |     | 0.95  |           | nC               |
| Turn-On DelayTime                     | $t_{D(\text{on})}$  | $V_{GS}=-10\text{V}, V_{DS}=-15\text{V}, R_L=5.8\Omega, R_{GEN}=3\Omega$ |     | 7.5   |           | ns               |
| Turn-On Rise Time                     | $t_r$               |  |     | 3.2   |           | ns               |
| Turn-Off DelayTime                    | $t_{D(\text{off})}$ |  |     | 17    |           | ns               |
| Turn-Off Fall Time                    | $t_f$               |  |     | 6.8   |           | ns               |
| Body Diode Reverse Recovery Time      | $t_{rr}$            | $I_F=-2.6\text{A}, dI/dt=100\text{A}/\mu\text{s}$                        |     | 16.8  | 22        | ns               |
| Body Diode Reverse Recovery Charge    | $Q_{rr}$            | $I_F=-2.6\text{A}, dI/dt=100\text{A}/\mu\text{s}$                        |     | 10    |           | nC               |
| Maximum Body-Diode Continuous Current | $I_s$               |  |     |       | -2        | A                |
| Diode Forward Voltage                 | $V_{SD}$            | $I_s=-1\text{A}, V_{GS}=0\text{V}$                                       |     | -0.82 | -1        | V                |

\* Repetitive rating, pulse width limited by junction temperature.

### ■ Typical Characteristics

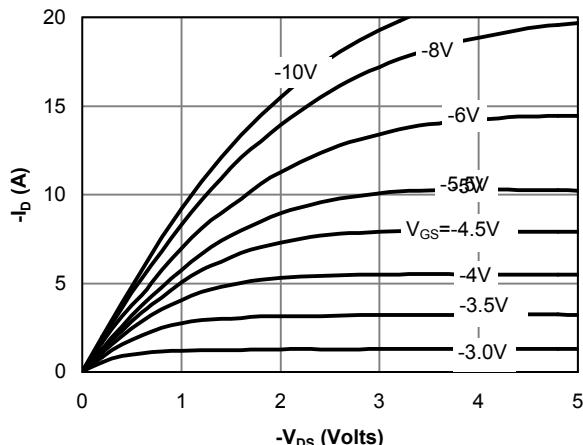


Fig 1: On-Region Characteristics

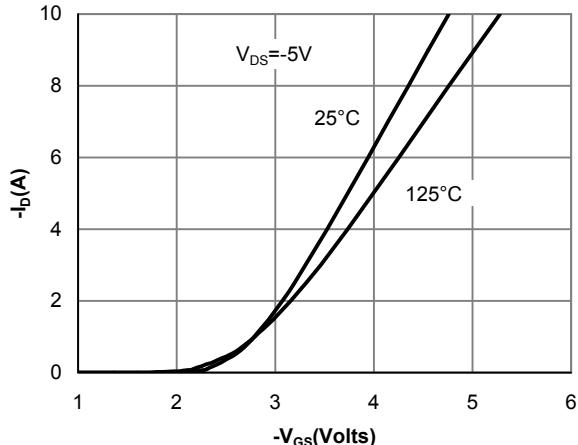


Figure 2: Transfer Characteristics

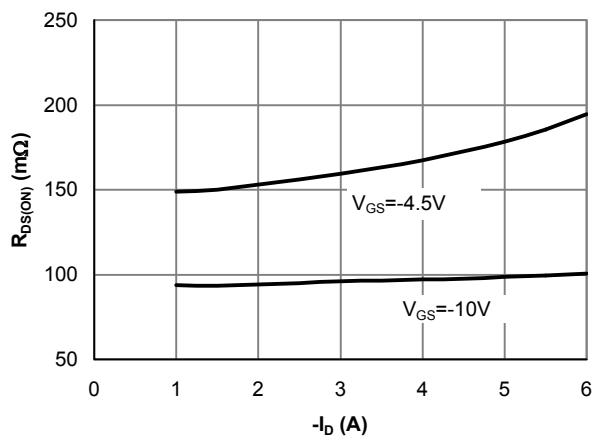


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

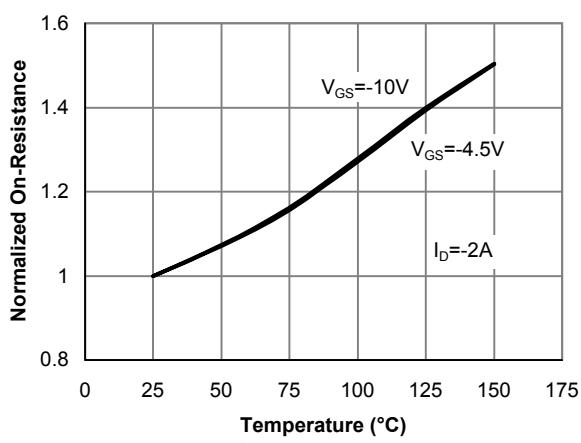


Figure 4: On-Resistance vs. Junction Temperature

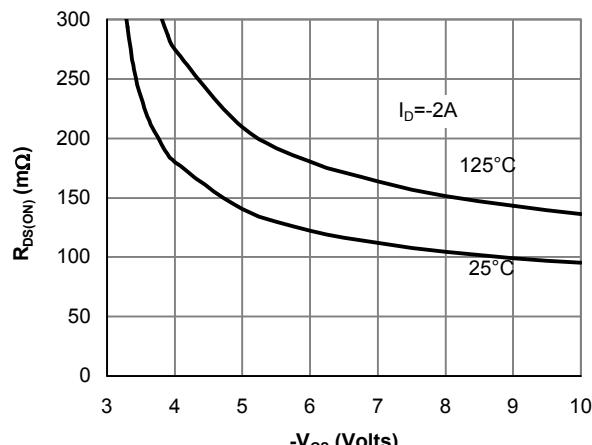


Figure 5: On-Resistance vs. Gate-Source Voltage

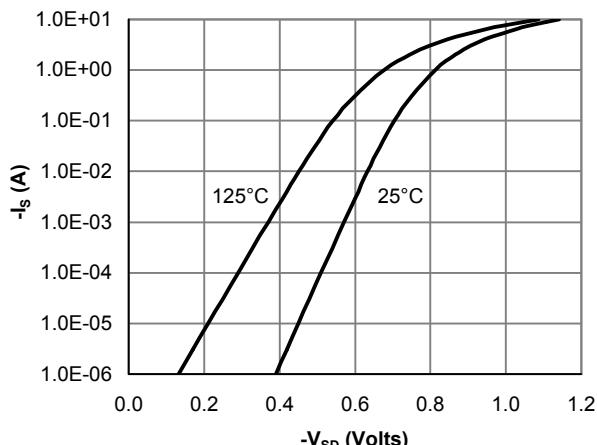
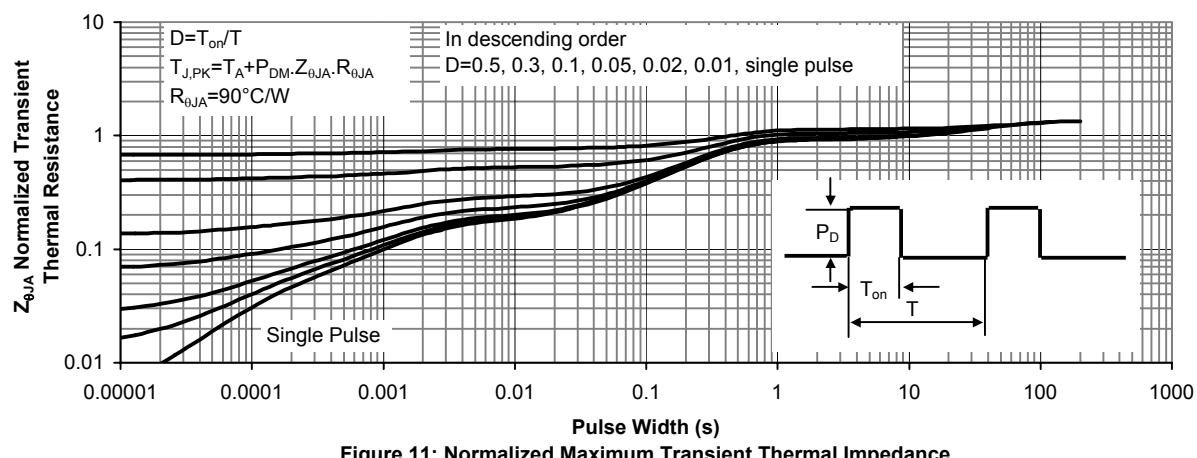
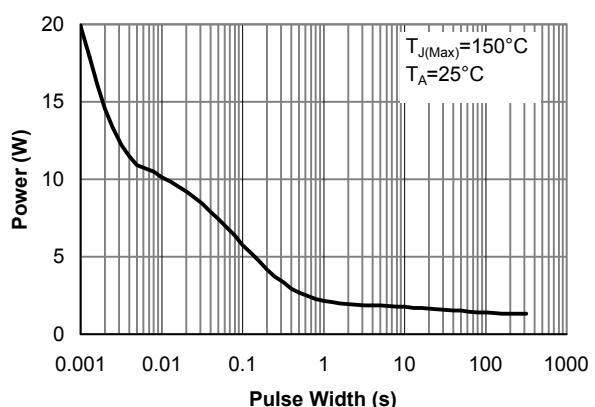
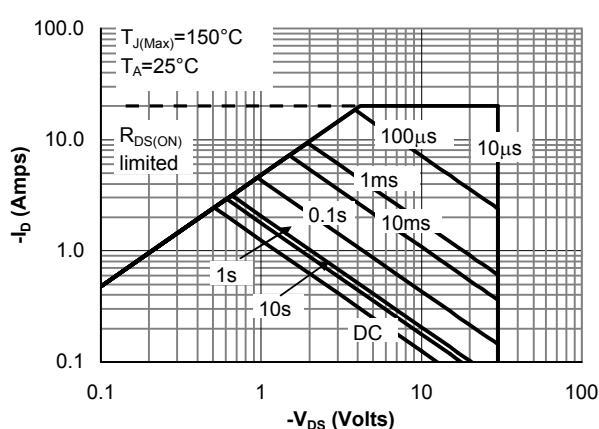
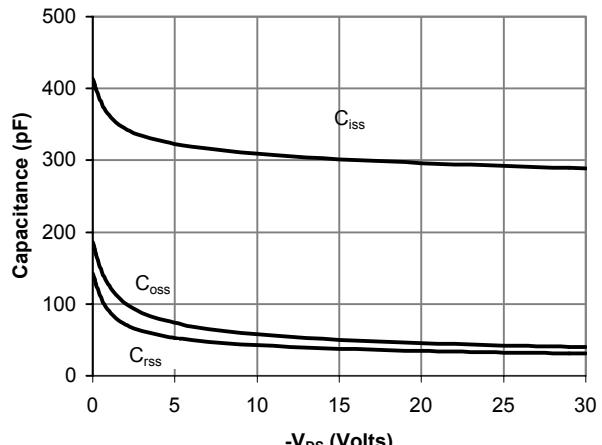
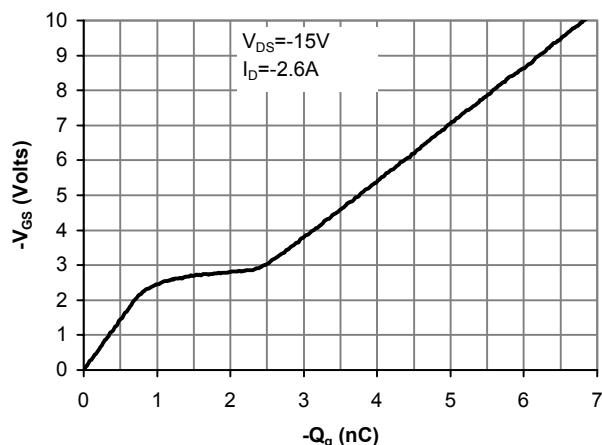
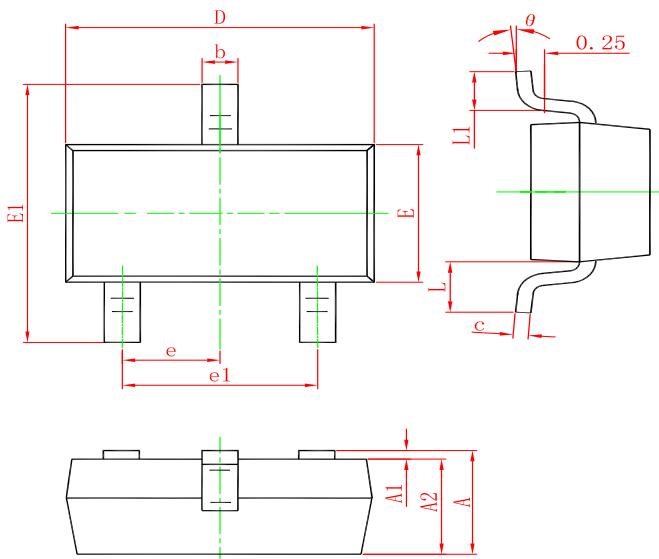


Figure 6: Body-Diode Characteristics

## ■ Typical Characteristics

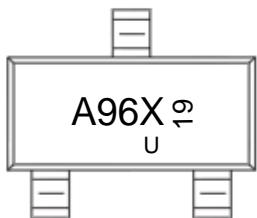


### SOT-23 PACKAGE OUTLINE DIMENSIONS



| Symbol | Dimensions In Millimeters |       | Dimensions In Inches |       |
|--------|---------------------------|-------|----------------------|-------|
|        | Min.                      | Max.  | Min.                 | Max.  |
| A      | 0.900                     | 1.150 | 0.035                | 0.045 |
| A1     | 0.000                     | 0.100 | 0.000                | 0.004 |
| A2     | 0.900                     | 1.050 | 0.035                | 0.041 |
| b      | 0.300                     | 0.500 | 0.012                | 0.020 |
| c      | 0.080                     | 0.150 | 0.003                | 0.006 |
| D      | 2.800                     | 3.000 | 0.110                | 0.118 |
| E      | 1.200                     | 1.400 | 0.047                | 0.055 |
| E1     | 2.250                     | 2.550 | 0.089                | 0.100 |
| e      | 0.950 TYP.                |       | 0.037 TYP.           |       |
| e1     | 1.800                     | 2.000 | 0.071                | 0.079 |
| L      | 0.550 REF.                |       | 0.022 REF.           |       |
| L1     | 0.300                     | 0.500 | 0.012                | 0.020 |
| θ      | 0°                        | 8°    | 0°                   | 8°    |

### Marking



### Ordering information

| Order code | Package | Baseqty | Deliverymode  |
|------------|---------|---------|---------------|
| AO3409A    | SOT-23  | 3000    | Tape and reel |